

Dell Validated Design for Manufacturing Edge with PTC

Solution Overview

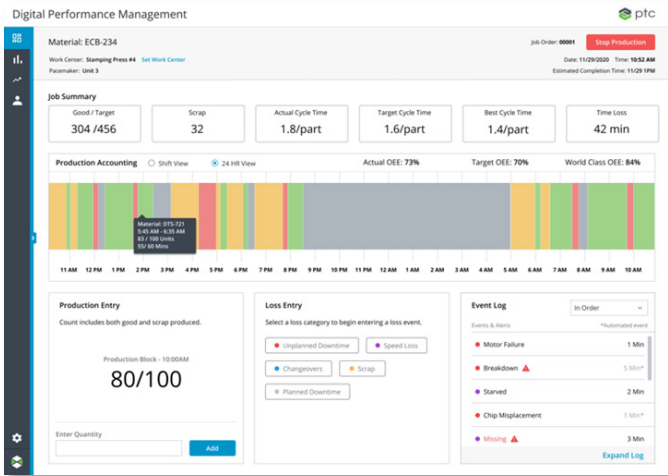
The Dell Validated Design for Manufacturing Edge with PTC is a scalable and interoperable solution to consolidate applications and power live insights for operational excellence. The solution simplifies infrastructure complexities at the edge and leverages PTC's ThingWorx platform with the Digital Performance Management (DPM) extension for continuous, prioritized process improvement.

- Consolidate for agility and efficiency by eliminating silos and simplifying the complexity of infrastructure management.
- Optimize with prioritized operational insights shared in real time across the operations hierarchy to facilitate decisions that unlock production hours.
- Scale up securely with fast, secure, and resilient edge performance using the underlying VxRail, from initial factory pilots to a global rollout.

Solution Detail

Within the Dell Validated Design for Manufacturing Edge with PTC, the following elements comprise the architecture.

- **Dell VxRail:** The VxRail hyperconverged infrastructure creates a turnkey deployment at the edge that offers maximum flexibility for HA, scale, and consolidation of OT workloads and applications. The VxRail underpins this joint solution with PTC – running both Thingworx and Kepware VMs as virtual machines.
- **Dell EMC Edge Gateway 5200:** The Edge Gateway helps companies connect OT/IT environments and extract value from edge-generated data with no interruptions to their infrastructure. Designed in a rugged, fanless design, the edge gateway is compact and robust enough to endure 24/7/365 operations. It powers real-time insights that will lead to better efficiency, lower costs, and greater performance for your business. Within this solution, the Dell Edge Gateway delivers industrial connectivity and IT/OT convergence with PTC Kepware.
- **PTC Thingworx:** Thingworx is a complete IIoT application platform that empowers industrial enterprises to digitally transform every aspect of their business with innovative solutions that are simple to create, easy to implement, and scalable to meet future needs and accelerate time to value.
- **PTC Kepware:** Designed for accurate communications, quick setup, and interoperability between client applications, industrial devices, and systems. It provides a wide range of plug-ins, device drivers, and components that suit most communication needs. Kepware enables convergence at the IT/OT layer within this solution.
- **PTC Digital Performance Management:** To drive continuous process improvement “beyond OEE”, unlock production hours with PTC’s Digital Performance Management.
 - Top-Down Performance Management conveyed in a singular metric, “Time Lost”
 - Continuous, real-time, closed loop problem solving
 - In-context measurement for production workers
 - Focus on priority process issues and use cases in manufacturing
 - Fast time to value and rapid implementation



Technical Specifications

These are the recommended configurations based on the Dell Validated Design.

PowerEdge Specifications

| | CPU | Cores | Threads | Memory |
|-------------------------|------------------------------------|---------------|---------------|--------|
| XR11 single node | 1x Intel® Xeon Silver 4316 2.3 GHz | 20 | 40 | 96 GB |
| XR12 Single Node | 1x Intel® Xeon Silver 4316 2.3 GHz | 20 | 40 | 96 GB |
| R650 Single Node | 2x Intel® Xeon Silver 4310 2.1 GHz | 12 per socket | 24 per socket | 96 GB |
| R750 Single Node | 2x Intel® Xeon Silver 4310 2.1 GHz | 12 per socket | 24 per socket | 192 GB |

VxRail Specifications

| | CPU | Cores | Threads | Memory |
|--------------------------|-------------------------------------|---------------|---------------|--------|
| E660F Single Node | 1x Intel® Xeon® Silver 4314 2.4 GHz | 16 | 32 | 128 GB |
| P670F Single Node | 2x Intel® Xeon® Gold 6246 3.1 GHz | 16 per socket | 32 per socket | 256 GB |

Edge Gateway Specifications

| Features | EGW-5200 | | |
|-----------------|---|-----------------------------|-----------------------------|
| Processor | Intel®Core™ i7-9700TE | Intel®Core™ i3-9100TETDP35W | Intel®Core™ i3-9100TETDP35W |
| # of Cores | 8 | 6 | 4 |
| Base Freq. | 1.8 GHz | 2.2 GHz | 2.2 GHz |
| Max Turbo Freq. | 3.8 GHz | 3.6 GHz | 3.2 GHz |
| Chipset | C246 | | |
| Memory | 2x DDR4 SO-DIMMs, up to 64 GB | | |
| Storage | 2.5" SATA 2x Internal | | |
| Power Supply | AC Input (optional): 180 W / 220 W, 60 W (for PoE) external AC/DC adapter DC Input: 12–24 V (±10% tolerance) | | |

PTC Software Specifications

| Product | Software Version | Base Operating Systems |
|---------------------------|------------------------------|--------------------------------------|
| PTC Thingworx | Thingworx Foundation 9.3.2.0 | Windows Server 2019 Linux Red Hat |
| PTC Thingworx Edge | Kepware Server 6.11.718.0 | Windows Server 2019 Linux Red Hat |
| PTC DPM | DPM 1.1.0.0 | N/A |

Solution Sizing

Small-scale configurations – PowerEdge and VxRail

| Specification | PowerEdge XR11 | PowerEdge XR12 | PowerEdge R650 | VxRail E660F |
|--------------------------------------|--|--|--|--|
| Compute and memory | | | | |
| CPU | 1x Intel Xeon Silver 4316 2.3 GHz | 1x Intel Xeon Silver 4316 2.3 GHz | 2x Intel Xeon Silver 4310 2.1 GHz | 1x Intel Xeon Silver 4314 2.4 GHz |
| Cores | 20 | 20 | 12 per socket | 16 |
| Threads | 40 | 40 | 24 per socket | 32 |
| Memory | 96 GB | 96 GB | 96 GB | 128 GB |
| Storage | | | | |
| Cache | N/A | N/A | N/A | 1x 800 GB SSD SAS |
| Capacity Drives | 4x 1.92 TB SSD vSAS | 4x 1.92 TB SSD vSAS | 4x 1.92 TB SSD vSAS | 3x 1.92 TB SSD vSAS capacity drives per node |
| BOSS Card (RAID 1) | 2x M.2 240 GB | 2x M.2 240 GB | 2x M.2 240 GB | 2x M.2 480 GB |
| Networking | | | | |
| Integrated physical interface | 4x 25 GbE SFP28 | 4x 25 GbE SFP28 | 2x 10/25 GbE SFP28 | 2x 10/25 GbE SFP28 |
| Platform | | | | |
| Power: AC PSU | 1400 W 100–240 V | 2x 800 W 100–240 V | 2x 1400 W 100–240 V | 2x 1100 W 100–240 V |
| Dimensions | 42.8 mm/1.68" H 482.6 mm/19" W 477 mm/18.77" D | 42.8 mm/1.68" H 482.6 mm/19" W 477 mm/18.77" D | 42.8 mm/1.68" H 482.6 mm/19" W 787.05 mm/31" D | 42.8 mm/1.68" H 482.6 mm/19" W 477 mm/18.77" D |
| Weight | 13.8 kg / 30.5 lb | 13.8 kg / 30.5 lb | 21.2 kg / 46.7 lb | 21 kg / 46.2 lb |
| Fans | 6 | 6 | 4 x 2 | 4 |
| Operating environment | | | | |
| Ambient operating temperature | 5–40°C / 41–104°F | 5–40°C / 41–104°F | 10–35°C / 50–95°F | 5–40°C / 41–104°F |
| Operating relative humidity | 8–85% (non- condensing) | 8–85% (non- condensing) | 8–80% (non- condensing) | 8–85% (non- condensing) |
| Operating altitude with no deratings | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft |
| Heat dissipation | 1400 W: 4100 BTU/h | 800 W: 3139 BTU/h | 1400 W: 5459 BTU/h each | 1400 W: 4299 BTU/h each |

Medium-scale configurations – PowerEdge

| Specification | PowerEdge XR11 | PowerEdge XR12 | PowerEdge R650 | PowerEdge R750 |
|--------------------------------------|--|--|--|--|
| Compute and memory | | | | |
| CPU | 1x Intel Xeon Gold 5318N 2.1 GHz | 1x Intel Xeon Gold 5318N 2.3 GHz | 2x Intel Xeon Silver 4310 2.1 GHz | 2x Intel Xeon Silver 4310 2.1 GHz |
| Cores | 24 | 24 | 12 per socket | 12 per socket |
| Threads | 48 | 48 | 24 per socket | 24 per socket |
| Memory | 192 GB | 192 GB | 192 GB | 192 GB |
| Storage | | | | |
| Capacity Drives | 3x 3.84 TB SSD vSAS | 3x 3.84 TB SSD vSAS | 3x 3.84 TB SSD vSAS | 3x 3.84 TB SSD SAS |
| BOSS Card (RAID 1) | 2x M.2 240 GB | 2x M.2 240 GB | 2x M.2 240 GB | 2x M.2 240 GB |
| Networking | | | | |
| Integrated physical interface | 4x 25 GbE SFP28 | 4x 25 GbE SFP28 | 2x 10/25 GbE SFP28 | 2x 10/25 GbE SFP28 |
| Platform | | | | |
| Power: AC PSU | 2x 1400 W 100–240 V | 2x 800 W 100–240 V | 2x 1400 W 100–240 V | 2x 1400 W 100–240 V |
| Dimensions | 42.8 mm/1.68" H 482.6 mm/19" W 477 mm/18.77" D | 42.8 mm/1.68" H 482.6 mm/19" W 477 mm/18.77" D | 42.8 mm/1.68" H 482.6 mm/19" W 787.05 mm/31" D | 42.8 mm/1.68" H 482.6 mm/19" W 787.05 mm/31" D |
| Weight | 13.8 kg / 30.5 lb | 13.8 kg / 30.5 lb | 21.2 kg / 46.7 lb | 21.2 kg / 46.7 lb |
| Fans | 6 | 6 | 4 x 2 | 4 x 2 |
| Operating environment | | | | |
| Ambient operating temperature | 5–40°C / 41–104°F | 5–40°C / 41–104°F | 10–35°C / 50–95°F | 10–35°C / 50–95°F |
| Operating relative humidity | 8–85% (non- condensing) | 8–85% (non- condensing) | 8–80% (non- condensing) | 8–80% (non- condensing) |
| Operating altitude with no deratings | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft |
| Heat dissipation | 1400 W: 4100 BTU/h each | 800 W: 3139 BTU/h each | 1400 W: 5459 BTU/h each | 1400 W: 5459 BTU/h each |

Medium-scale configuration – VxRail

| Specification | VxRail E660F |
|--------------------------------------|---|
| Compute and memory | |
| CPU | 2x Intel Xeon Silver 4310 2.1 GHz |
| Cores | 10 per socket |
| Threads | 20 per socket |
| Memory | 256 GB |
| Storage | |
| Cache | 2x 800 GB SSD SAS |
| Capacity Drives | 4x 3.84 TB SSD SAS capacity drives per node |
| BOSS Card (RAID 1) | 2x M.2 480 GB |
| Networking | |
| Integrated physical interface | 2x 10/25 GbE SFP28 |
| Platform | |
| Power: AC PSU | 2x 1400 W 100–240 V |
| Dimensions | 42.8 mm/1.68" H |
| Weight | 21 kg / 46.2 lb |
| Fans | 4 |
| Operating environment | |
| Ambient operating temperature | 10–30°C / 41–104°F |
| Operating relative humidity | 10–80% (non-condensing) |
| Operating altitude with no deratings | 3048 m approx. 10,000 ft |
| Heat dissipation | 1400 W: 41000 BTU/h each |

Large-scale configurations – PowerEdge and VxRail

| Specification | PowerEdge R650 | PowerEdge R750 | VxRail E660F | VxRail P670F |
|--------------------------------------|--|--|---|---|
| Compute and memory | | | | |
| CPU | 2x Intel Xeon Platinum 8368 2.4 GHz | 2x Intel Xeon Platinum 8368 2.1 GHz | 2x Intel Xeon Gold 6326 2.9 GHz | 2x Intel Xeon Gold 6246 3.1 GHz |
| Cores | 38 per socket | 38 per socket | 16 per socket | 16 per socket |
| Threads | 76 per socket | 76 per socket | 32 per socket | 32 per socket |
| Memory | 256 GB | 256 GB | 256 GB | 256 GB |
| Storage | | | | |
| Cache | N/A | N/A | 2x 800 GB SSD SAS | 2x 800 GB SSD SAS |
| Capacity Drives | 6x 3.84 TB SSD vSAS | 6x 3.84 TB SSD vSAS | 6x 3.84 TB SSD SAS capacity drives per node | 6x 3.84 TB SSD SAS capacity drives per node |
| BOSS Card (RAID 1) | 2x M.2 240 GB | 2x M.2 240 GB | 2x M.2 480 GB | 2x M.2 480 GB |
| MicroSDHC/SDXC | N/A | N/A | N/A | 64 GB |
| Networking | | | | |
| Integrated physical interface | 2x 10/25 GbE SFP28 | 2x 10/25 GbE SFP28 | 2x 10/25 GbE SFP28 | 4x 10 GbE SFP28 |
| Platform | | | | |
| Power: AC PSU | 2x 1400 W 100–240 V | 2x 1400 W 100–240 V | 2x 550 W 100–240 V | 2x 1400 W 100–240 V |
| Dimensions | 42.8 mm/1.68" H 482.6 mm/19" W 787.05 mm/31" D | 42.8 mm/1.68" H 482.6 mm/19" W 787.05 mm/31" D | 42.8 mm/1.68" H 434 mm/17.09" W 433 mm/29.61" D | 86.8 mm/3.42" H 434 mm/17.09" W 647 mm/25.47" D |
| Weight | 21.2 kg / 46.7 lb | 21.2 kg / 46.7 lb | 21 kg / 46.2 lb | 23.72 kg / 52.29 lb |
| Fans | 4 x 2 | 4 x 2 | 6 | 6 |
| Operating environment | | | | |
| Ambient operating temperature | 10–35°C / 50–95°F | 10–35°C / 50–95°F | 10–35°C / 50–95°F | 10–35°C / 50–95°F |
| Operating relative humidity | 8–80% (non- condensing) | 8–80% (non- condensing) | 8–80% (non- condensing) | 8–85% (non- condensing) |
| Operating altitude with no deratings | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft | 3048 m approx. 10,000 ft |
| Heat dissipation | 1400 W: 5459 BTU/h each | 1400 W: 5459 BTU/h each | 1400 W: 5459 BTU/h each | 1400 W: 5459 BTU/h each |